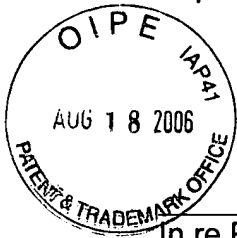


Express Mail Label No. EV881852201US



Docket No.: 427008007US  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Heng et al.

Application No.: 09/254,521

Confirmation Number: 7143

Filed: September 5, 1997

Art Unit: 2877

For: MICRO DEFECTS IN SEMI-CONDUCTORS Examiner: H. Q. Pham

**SUBMISSION OF DRAWINGS**

MS Issue Fee  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450


Sir:

Submitted herewith is one set (five sheets, nine figures) of drawings for filing in the above-identified patent application. Kindly substitute the enclosed drawings for the drawings submitted with the originally filed application.

Applicant believes no fee is due with this response. However, if a fee is due, please charge our Deposit Account No. 50-0665, under Order No. 427008007US from which the undersigned is authorized to draw.

Dated: August 18, 2006

Respectfully submitted,

By   
Paul T. Parker

Registration No.: 38,264  
PERKINS COIE LLP  
P.O. Box 1247  
Seattle, Washington 98111-1247  
(206) 359-8000  
(206) 359-7198 (Fax)  
Attorney for Applicant